

FEATURES

- 10µs Short Circuit Withstand
- High Thermal Cycling Capability
- Non Punch Through Silicon
- Isolated AISiC Base with AlN Substrates
- Lead Free construction

APPLICATIONS

- High Reliability Inverters
- Motor Controllers
- Traction Drives

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 1200V to 6500V and currents up to 2400A.

The DIM600DDM17-A000 is a dual switch 1700V, n-channel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA) plus 10µs short circuit withstand. This device is optimised for traction drives and other applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DIM600DDM17-A000

Note: When ordering, please use the complete part number

KEY PARAMETERS

V_{CES}	1700V
$V_{CE(sat)}$ * (typ)	2.7 V
I_C (max)	600A
$I_{C(PK)}$ (max)	1200A

* Measured at the power busbars, not the auxiliary terminals

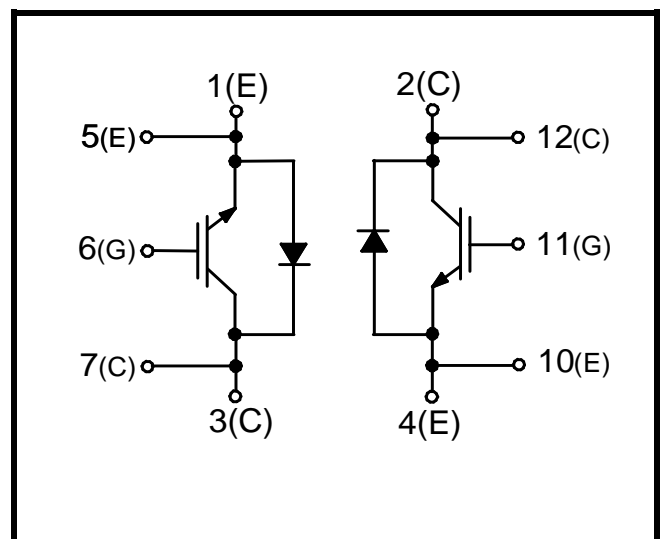
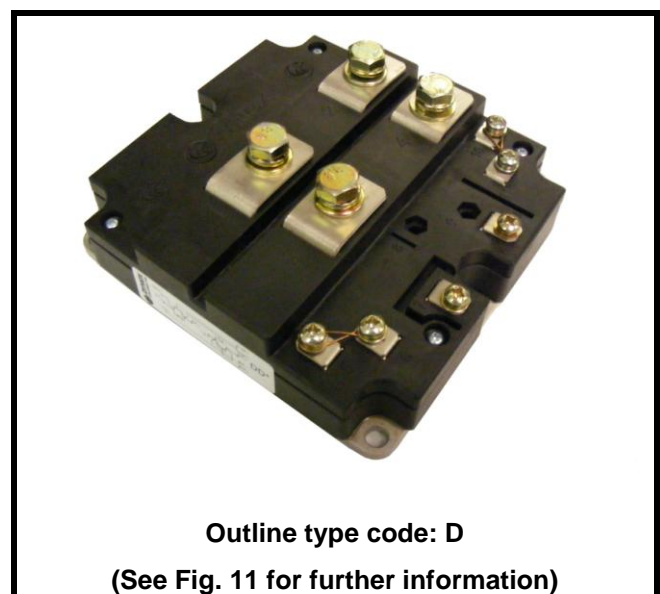


Fig. 1 Circuit configuration



Outline type code: D

(See Fig. 11 for further information)

Fig. 2 Package

ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

$T_{case} = 25^{\circ}\text{C}$ unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
V_{CES}	Collector-emitter voltage	$V_{GE} = 0V$	1700	V
V_{GES}	Gate-emitter voltage		± 20	V
I_C	Continuous collector current	$T_{case} = 75^{\circ}\text{C}$	600	A
$I_{C(PK)}$	Peak collector current	1ms, $T_{case} = 105^{\circ}\text{C}$	1200	A
P_{max}	Max. transistor power dissipation	$T_{case} = 25^{\circ}\text{C}$, $T_j = 150^{\circ}\text{C}$	5200	W
I^2t	Diode I^2t value	$V_R = 0$, $t_p = 10\text{ms}$, $T_j = 125^{\circ}\text{C}$	120	kA^2s
V_{isol}	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	4000	kV
Q_{PD}	Partial discharge – per module	IEC1287, $V_1 = 1800V$, $V_2 = 1300V$, 50Hz RMS	10	pC

THERMAL AND MECHANICAL RATINGS

Internal insulation material:	AlN
Baseplate material:	AlSiC
Creepage distance:	20mm
Clearance:	10mm
CTI (Comparative Tracking Index):	350

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Units
$R_{th(j-c)}$	Thermal resistance – transistor (per switch)	Continuous dissipation - junction to case		-	24	$^{\circ}\text{C}/\text{kW}$
$R_{th(j-c)}$	Thermal resistance – diode (per switch)	Continuous dissipation - junction to case		-	40	$^{\circ}\text{C}/\text{kW}$
$R_{th(c-h)}$	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)		-	8	$^{\circ}\text{C}/\text{kW}$
T_j	Junction temperature	Transistor	-	-	150	$^{\circ}\text{C}$
		Diode	-	-	125	$^{\circ}\text{C}$
T_{stg}	Storage temperature range	-	-40	-	125	$^{\circ}\text{C}$
	Screw torque	Mounting – M6	-	-	5	Nm
		Electrical connections – M4	-	-	2	Nm
		Electrical connections – M8	-	-	10	Nm

ELECTRICAL CHARACTERISTICS

 T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
I _{CES}	Collector cut-off current	V _{GE} = 0V, V _{CE} = V _{CES}			1	mA
		V _{GE} = 0V, V _{CE} = V _{CES} , T _{case} = 125°C			20	mA
I _{GES}	Gate leakage current	V _{GE} = ± 20V, V _{CE} = 0V			4	μA
V _{GE(TH)}	Gate threshold voltage	I _C = 30mA, V _{GE} = V _{CE}	4.5	5.5	6.5	V
V _{CE(sat)} [†]	Collector-emitter saturation voltage	V _{GE} = 15V, I _C = 600A		2.7	3.2	V
		V _{GE} = 15V, I _C = 600A, T _j = 125°C		3.4	4.0	V
I _F	Diode forward current	DC			600	A
I _{FM}	Diode maximum forward current	t _p = 1ms			1200	A
V _F [†]	Diode forward voltage	I _F = 600A		2.0	2.3	V
		I _F = 600A, T _j = 125°C		2.1	2.4	V
C _{ies}	Input capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz		45		nF
Q _g	Gate charge	±15V		6.8		μC
C _{res}	Reverse transfer capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz				nF
L _M	Module inductance – per switch			3.8		nH
R _{INT}	Internal transistor resistance – per switch			270		μΩ
SC _{Data}	Short circuit current, I _{SC}	T _j = 125°C, V _{CC} = 1000V t _p ≤ 10μs, V _{GE} ≤ 15V V _{CE(max)} = V _{CES} – L* x di/dt IEC 60747-9		2400		A

Note:
[†] Measured at the power busbars, not the auxiliary terminals

^{*} L is the circuit inductance + L_M

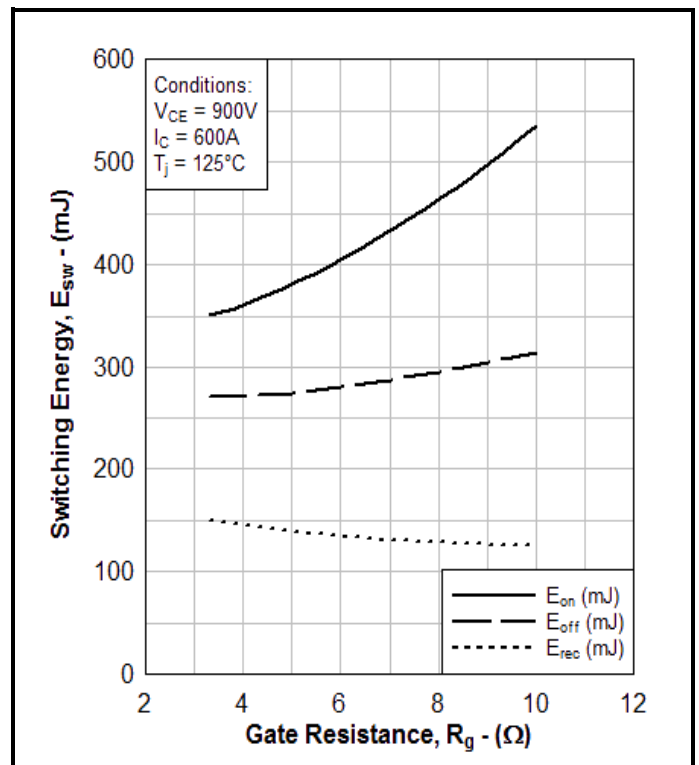
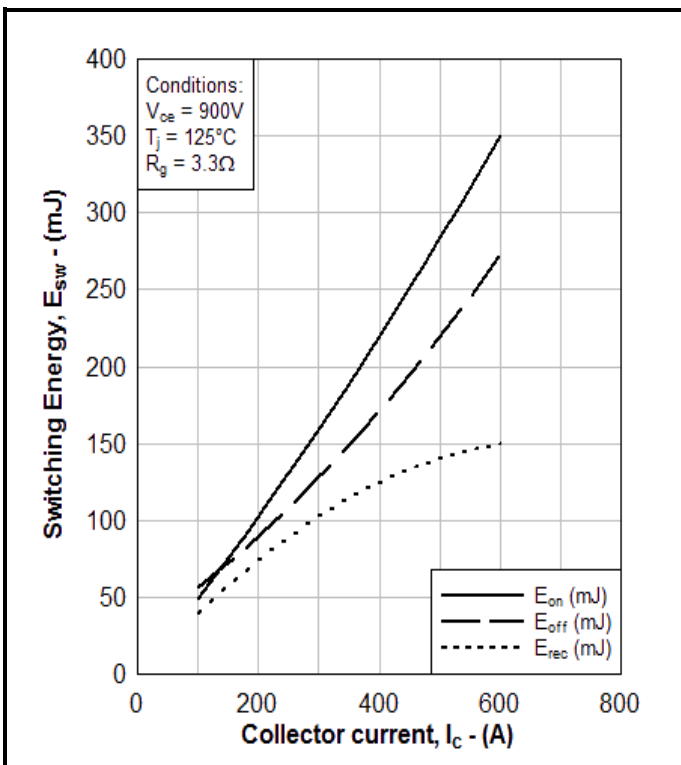
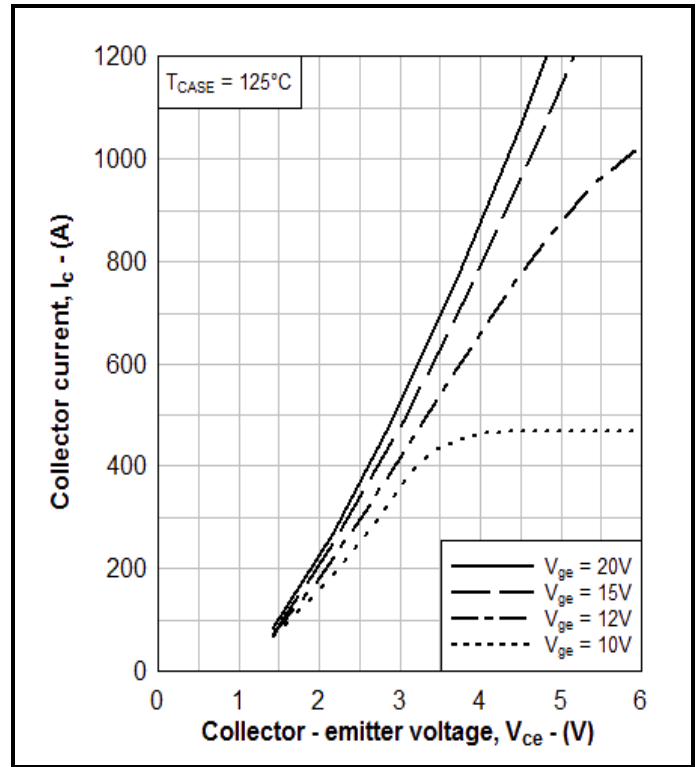
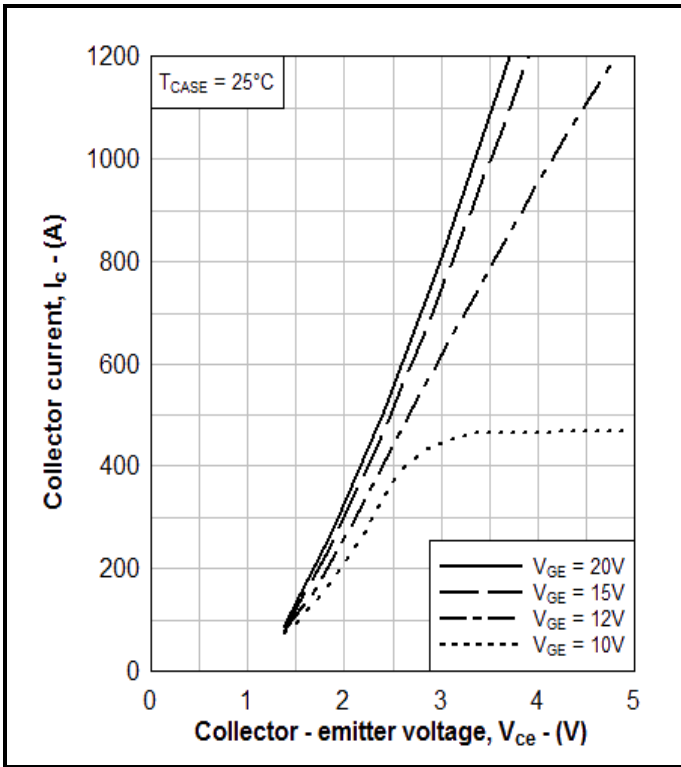
ELECTRICAL CHARACTERISTICS

$T_{case} = 25^{\circ}\text{C}$ unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Units
$t_{d(off)}$	Turn-off delay time	$I_C = 600\text{A}$ $V_{GE} = \pm 15\text{V}$ $V_{CE} = 900\text{V}$ $R_{G(ON)} = 3.3\Omega$ $R_{G(OFF)} = 3.3\Omega$ $L_S \sim 100\text{nH}$		1200		ns
t_f	Fall time			140		ns
E_{OFF}	Turn-off energy loss			190		mJ
$t_{d(on)}$	Turn-on delay time			250		ns
t_r	Rise time			250		ns
E_{ON}	Turn-on energy loss			220		mJ
Q_{rr}	Diode reverse recovery charge	$I_F = 600\text{A}$ $V_{CE} = 900\text{V}$ $di_F/dt = 3000\text{A}/\mu\text{s}$		150		μC
I_{rr}	Diode reverse recovery current			350		A
E_{rec}	Diode reverse recovery energy			100		mJ

$T_{case} = 125^{\circ}\text{C}$ unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Units
$t_{d(off)}$	Turn-off delay time	$I_C = 600\text{A}$ $V_{GE} = \pm 15\text{V}$ $V_{CE} = 900\text{V}$ $R_{G(ON)} = 3.3\Omega$ $R_{G(OFF)} = 3.3\Omega$ $L_S \sim 100\text{nH}$		1500		ns
t_f	Fall time			170		ns
E_{OFF}	Turn-off energy loss			270		mJ
$t_{d(on)}$	Turn-on delay time			400		ns
t_r	Rise time			250		ns
E_{ON}	Turn-on energy loss			350		mJ
Q_{rr}	Diode reverse recovery charge	$I_F = 600\text{A}$ $V_{CE} = 900\text{V}$ $di_F/dt = 3000\text{A}/\mu\text{s}$		250		μC
I_{rr}	Diode reverse recovery current			400		A
E_{rec}	Diode reverse recovery energy			150		mJ



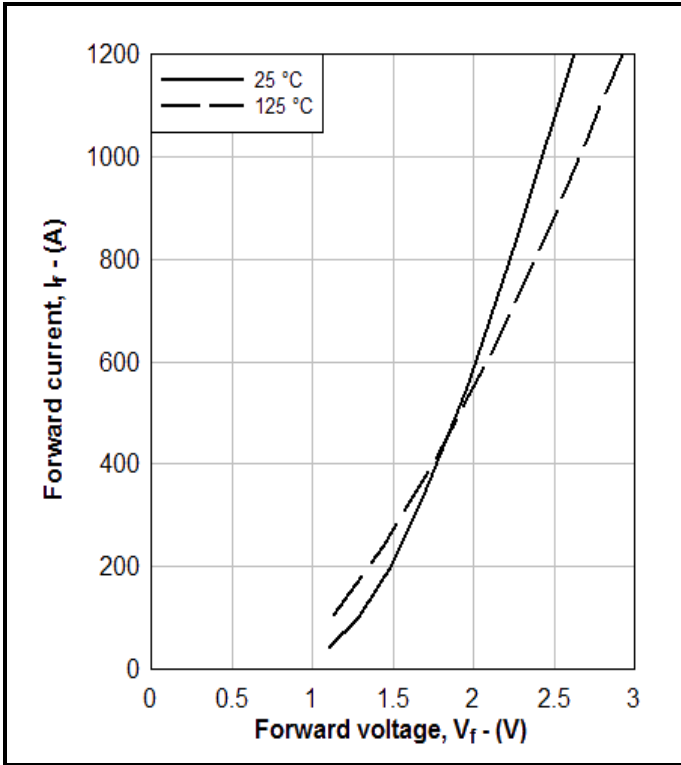


Fig. 7 Diode typical forward characteristics

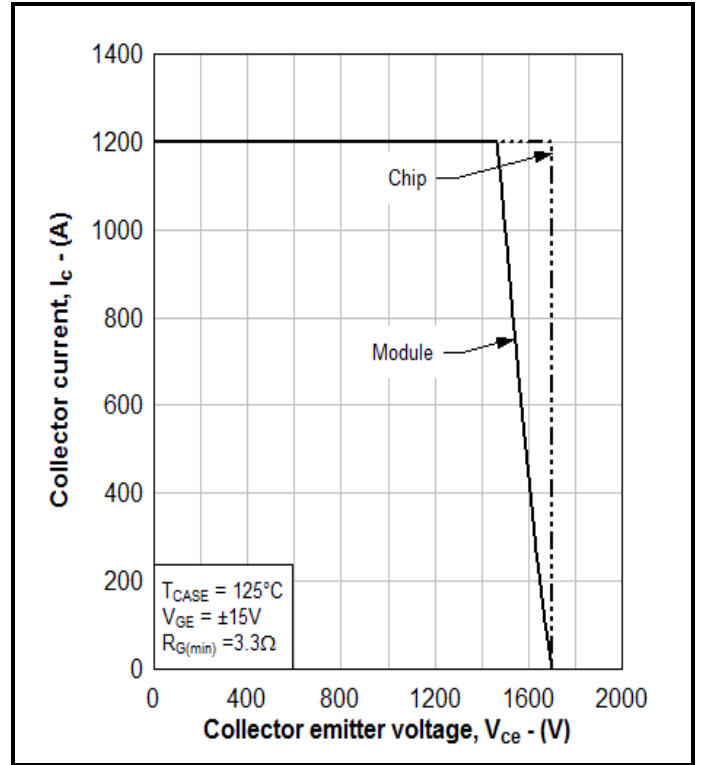


Fig. 8 Reverse bias safe operating area

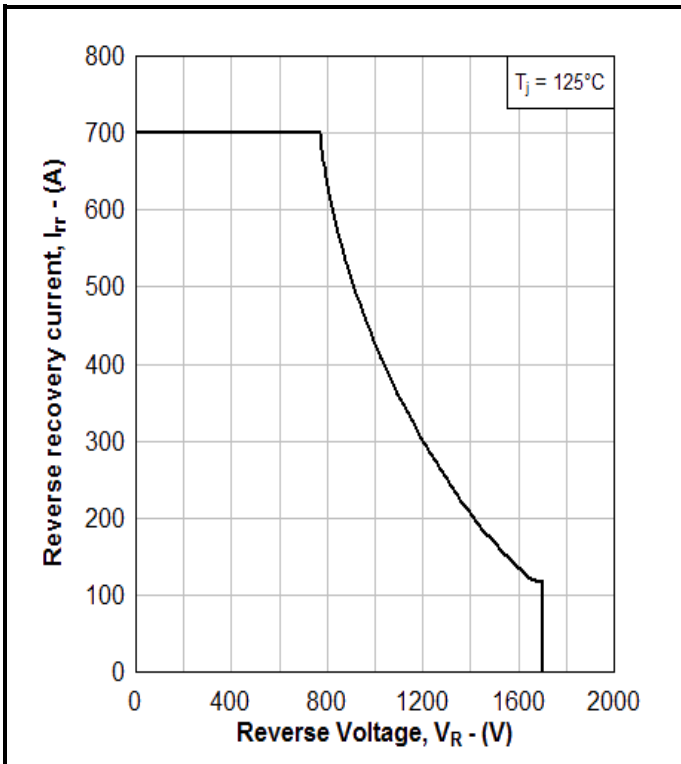


Fig. 9 Diode reverse bias safe operating area

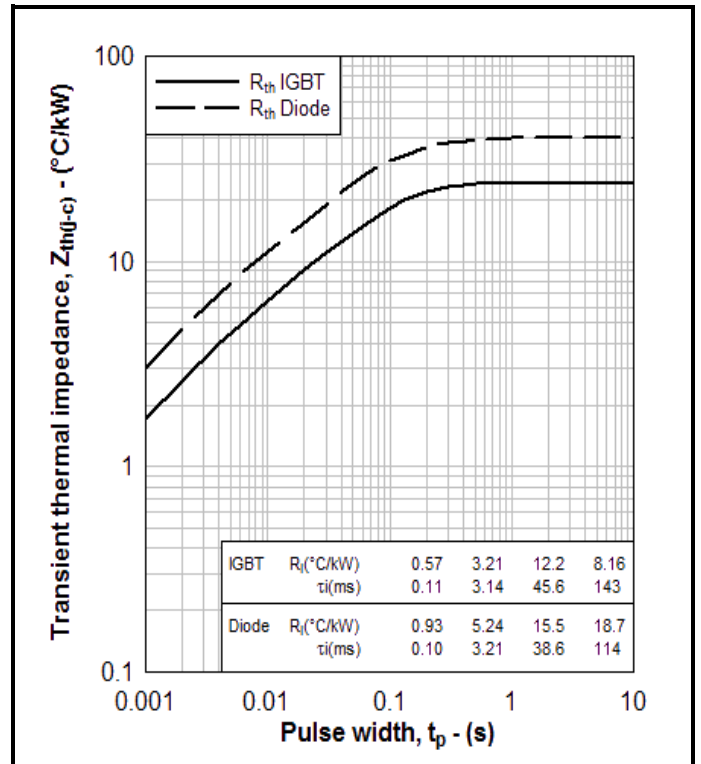
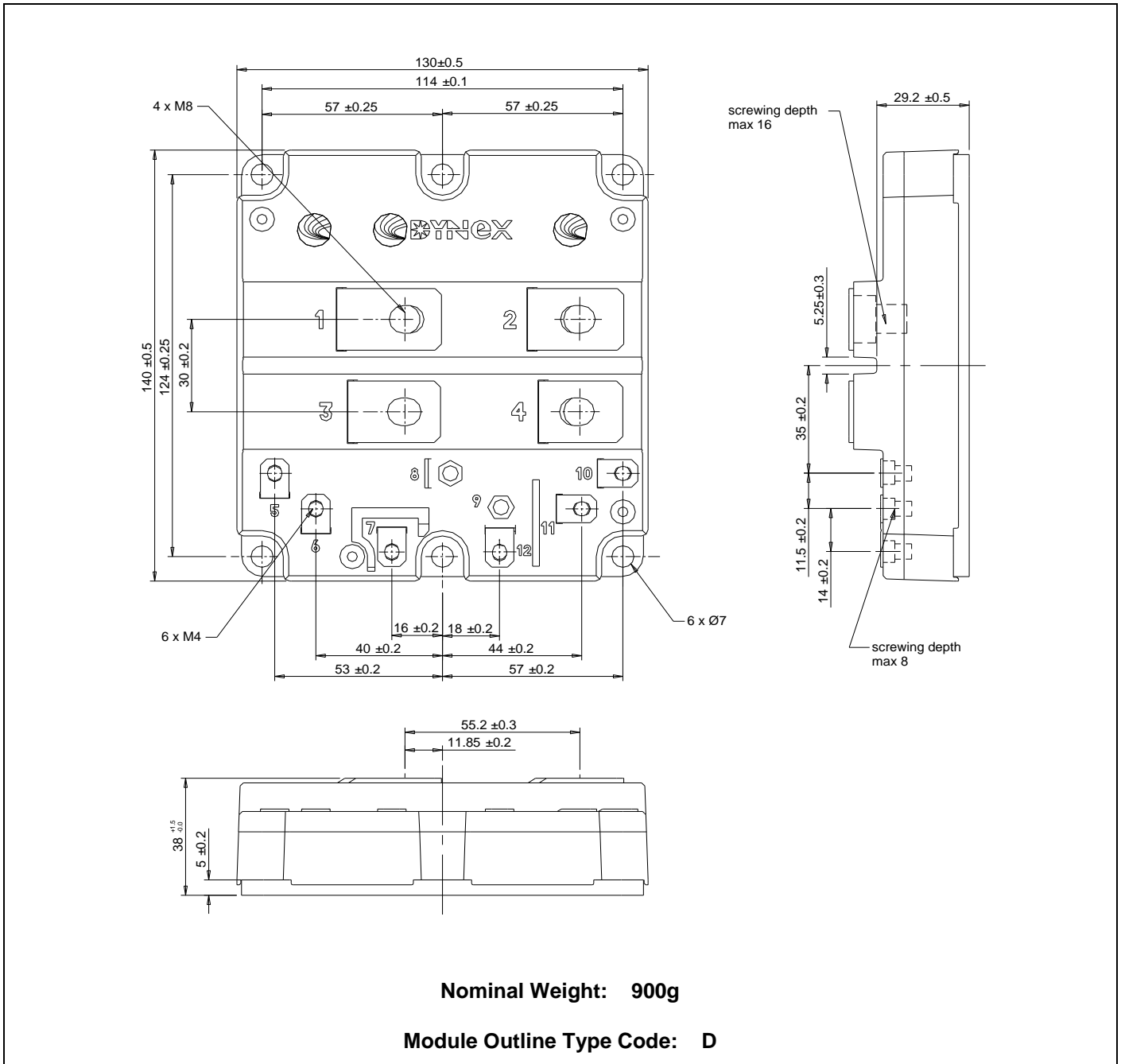


Fig. 10 Transient thermal impedance

PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services.
 All dimensions in mm, unless stated otherwise.
DO NOT SCALE.


Fig. 11 Module outline drawing

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HEADQUARTERS OPERATIONS

DYNEX SEMICONDUCTOR LTD

Doddington Road, Lincoln, Lincolnshire, LN6 3LF,
United Kingdom

Fax: +44(0)1522 500550

Tel: +44(0)1522 500500

Web: <http://www.dynexsemi.com>

CUSTOMER SERVICE

DYNEX SEMICONDUCTOR LTD

Doddington Road, Lincoln, Lincolnshire, LN6 3LF,
United Kingdom

Fax: +44(0)1522 500020

Tel: +44(0)1522 502753 / 502901

Email: Power_solutions@dynexsemi.com